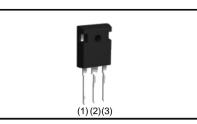


# RGS50TSX2DHR

1200V 25A Field Stop Trench IGBT

V <sub>CES</sub>	1200V
I <sub>C (100°C)</sub>	25A
V <sub>CE(sat) (Typ.)</sub>	1.7V
P <sub>D</sub>	395W

## •Outline



#### Inner Circuit

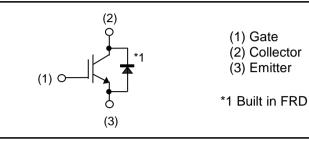


- 1) Low Collector Emitter Saturation Voltage
- 2) Short Circuit Withstand Time 10µs
- 3) Qualified to AEC-Q101
- 4) Built in Very Fast & Soft Recovery FRD
- 5) Pb free Lead Plating ; RoHS Compliant

#### Application

General Inverter

for Automotive and Industrial Use



#### Packaging Specifications

	Packaging	Tube
	Reel Size (mm)	-
Tuno	Tape Width (mm)	-
Туре	Basic Ordering Unit (pcs)	450
	Packing Code	C11
	Marking	RGS50TSX2D

#### •Absolute Maximum Ratings (at T<sub>C</sub> = 25°C unless otherwise specified)

Parameter		Symbol	Value	Unit
Collector - Emitter Voltage		V <sub>CES</sub>	1200	V
Gate - Emitter Voltage		V <sub>GES</sub>	±30	V
Collector Current	$T_{\rm C} = 25^{\circ}{\rm C}$	Ι <sub>C</sub>	50	А
Collector Current	$T_{\rm C} = 100^{\circ}{\rm C}$	Ι <sub>C</sub>	25	А
Pulsed Collector Current		I <sub>CP</sub> *1	75	А
Diode Forward Current	$T_{\rm C} = 25^{\circ}{\rm C}$	I <sub>F</sub>	50	А
	$T_{\rm C} = 100^{\circ}{\rm C}$	١ <sub>F</sub>	25	А
Diode Pulsed Forward Current		I <sub>FP</sub> <sup>*1</sup>	75	А
Dawar Diagination	$T_{\rm C} = 25^{\circ}{\rm C}$	P <sub>D</sub>	395	W
Power Dissipation	$T_{\rm C} = 100^{\circ}{\rm C}$	P <sub>D</sub>	197	W
Operating Junction Temperature		T <sub>j</sub>	-40 to +175	°C
Storage Temperature		T <sub>stg</sub>	-55 to +175	°C

\*1 Pulse width limited by  $T_{\text{jmax.}}$ 

#### •Thermal Resistance

Parameter	Symbol	Values			Unit
Falameter	Symbol	Min.	Тур.	Max.	Unit
Thermal Resistance IGBT Junction - Case	$R_{\theta(j\text{-}c)}$	-	-	0.38	°C/W
Thermal Resistance Diode Junction - Case	$R_{\theta(j-c)}$	-	-	0.80	°C/W

## •IGBT Electrical Characteristics (at $T_j = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol Conditions			Unit		
Farameter	Symbol	Conditions	Min.	Тур.	Max.	Offic
Collector - Emitter Breakdown Voltage	BV <sub>CES</sub>	$I_{C}$ = 10µA, $V_{GE}$ = 0V	1200	-	-	V
		$V_{CE} = 1200V, V_{GE} = 0V$				
Collector Cut - off Current	$I_{CES}$	T <sub>j</sub> = 25°C T <sub>i</sub> = 175°C	-	-	10	μA
		T <sub>j</sub> = 175°C	-	2	-	mA
Gate - Emitter Leakage Current	I <sub>GES</sub>	$V_{GE} = \pm 30V, V_{CE} = 0V$	-	-	±500	nA
Gate - Emitter Threshold Voltage	$V_{\text{GE(th)}}$	V <sub>CE</sub> = 5V, I <sub>C</sub> = 3.8mA	5.0	6.0	7.0	V
		I <sub>C</sub> = 25A, V <sub>GE</sub> = 15V				
Collector - Emitter Saturation Voltage	V <sub>CE(sat)</sub>	T <sub>j</sub> = 25°C T <sub>j</sub> = 175°C	-	1.70	2.10	V
		T <sub>j</sub> = 175°C	-	2.20	-	V

#### RGS50TSX2DHR

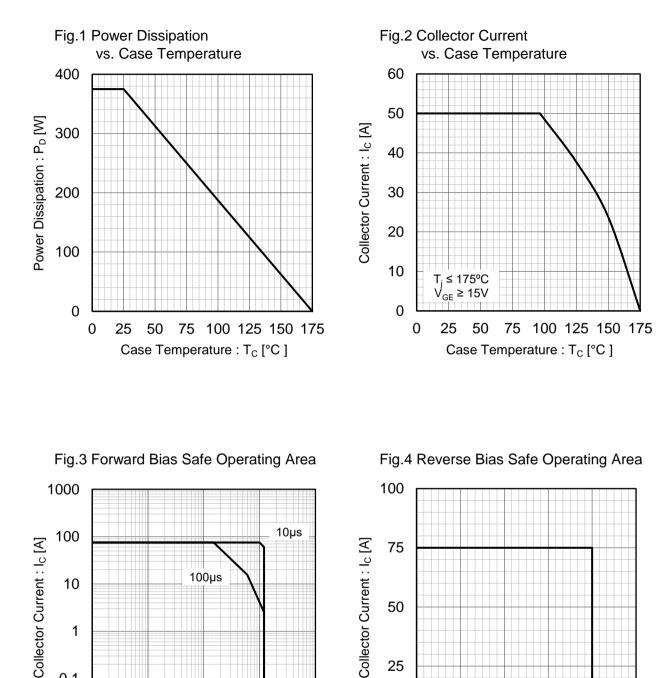
### •IGBT Electrical Characteristics (at $T_j = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Conditions	Values			1.1	
			Min.	Тур.	Max.	Unit	
Input Capacitance	C <sub>ies</sub>	$V_{CE} = 30V$	-	2095	-	pF	
Output Capacitance	C <sub>oes</sub>	V <sub>GE</sub> = 0V	-	166	-		
Reverse transfer Capacitance	C <sub>res</sub>	f = 1MHz	-	12	-		
Total Gate Charge	Qg	V <sub>CE</sub> = 500V	-	67	-		
Gate - Emitter Charge	Q <sub>ge</sub>	I <sub>C</sub> = 25A	-	19	-	nC	
Gate - Collector Charge	Q <sub>gc</sub>	V <sub>GE</sub> = 15V	-	25	-		
Turn - on Delay Time	t <sub>d(on)</sub>		-	37	-		
Rise Time	t <sub>r</sub>	$I_{\rm C} = 25$ A, $V_{\rm CC} = 600$ V,	-	16	-	ns	
Turn - off Delay Time	t <sub>d(off)</sub>	f Inductive Load - 2	-	140	-		
Fall Time	t <sub>f</sub>		205	-			
Turn-on Switching Loss	E <sub>on</sub>		-	1.40	-	mJ	
Turn-off Switching Loss	E <sub>off</sub>		-	1.65	-		
Turn - on Delay Time	t <sub>d(on)</sub>		-	36	-		
Rise Time	t <sub>r</sub>	I <sub>C</sub> = 25A, V <sub>CC</sub> = 600V, V <sub>GE</sub> = 15V, R <sub>G</sub> = 10Ω,	-	17	-		
Turn - off Delay Time	t <sub>d(off)</sub>	$T_i = 175^{\circ}C$	-	170	-	ns	
Fall Time	t <sub>f</sub>	Inductive Load	-	280	-	]	
Turn-on Switching Loss	E <sub>on</sub>	*E <sub>on</sub> include diode reverse recovery	-	1.50	-	~	
Turn-off Switching Loss	E <sub>off</sub>		-	2.20	-	mJ	
Reverse Bias Safe Operating Area	RBSOA	$I_{C} = 75A, V_{CC} = 1050V$ $V_{p} = 1200V, V_{GE} = 15V$ $R_{G} = 50\Omega, T_{j} = 175^{\circ}C$	FULL SQUARE		-		
Short Circuit Withstand Time	t <sub>sc</sub>	$V_{CC} \le 600V$ $V_{GE} = 15V, T_j = 25^{\circ}C$	10	-	-	μs	
Short Circuit Withstand Time	t <sub>sc</sub> *2	V <sub>CC</sub> ≤ 600V V <sub>GE</sub> = 15V, T <sub>j</sub> = 150°C	8	-	-	μs	

\*2 Design assurance without measurement

## •FRD Electrical Characteristics (at $T_j = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Conditions	Values			L locit
	Symbol	Conditions	Min.	Тур.	Max.	Unit
		I <sub>F</sub> = 25A				
Diode Forward Voltage	V <sub>F</sub>	T <sub>j</sub> = 25°C	-	1.65	2.10	V
		T <sub>j</sub> = 175°C	-	1.85	-	
Diode Reverse Recovery Time	t <sub>rr</sub>		-	182	-	ns
Diode Peak Reverse Recovery Current	I <sub>rr</sub>	$I_{F} = 25A$ $V_{CC} = 600V$ $di_{F}/dt = 500A/\mu s$ $T_{j} = 25^{\circ}C$	-	15.7	-	A
Diode Reverse Recovery Charge	Q <sub>rr</sub>		-	1.7	-	μC
Diode Reverse Recovery Energy	E <sub>rr</sub>		-	422	-	μJ
Diode Reverse Recovery Time	t <sub>rr</sub>		-	248	-	ns
Diode Peak Reverse Recovery Current	I <sub>rr</sub>	I <sub>F</sub> = 25A V <sub>CC</sub> = 600V	-	17.8	-	A
Diode Reverse Recovery Charge	Q <sub>rr</sub>	di <sub>F</sub> /dt = 500A/µs T <sub>j</sub> = 175°C	-	2.7	-	μC
Diode Reverse Recovery Energy	E <sub>rr</sub>		-	787	-	μJ





 $T_{c} = 25^{\circ}C$ 

Single Pulse

10

100

Collector To Emitter Voltage : V<sub>CE</sub> [V]

1000

10000

1

0.1

0.01

1

25

0

0

T<sub>i</sub> ≤ 175°C

Ѵ<sub>́GE</sub> = 15V

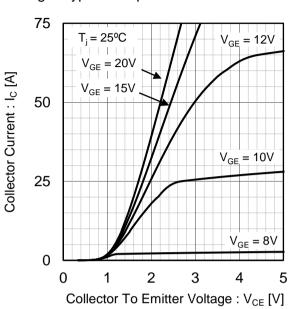
300

600

900

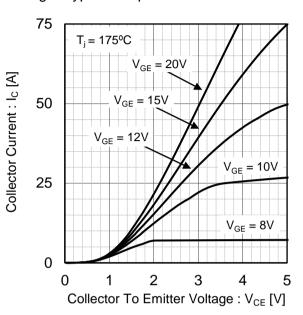
Collector To Emitter Voltage : V<sub>CE</sub> [V]

1200 1500



#### Fig.5 Typical Output Characteristics

#### Fig.6 Typical Output Characteristics



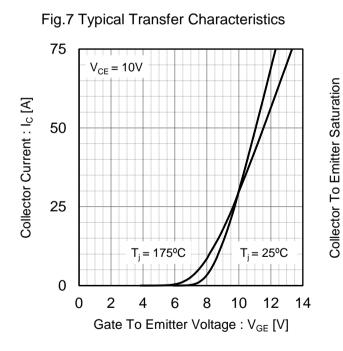
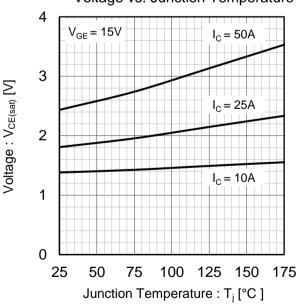
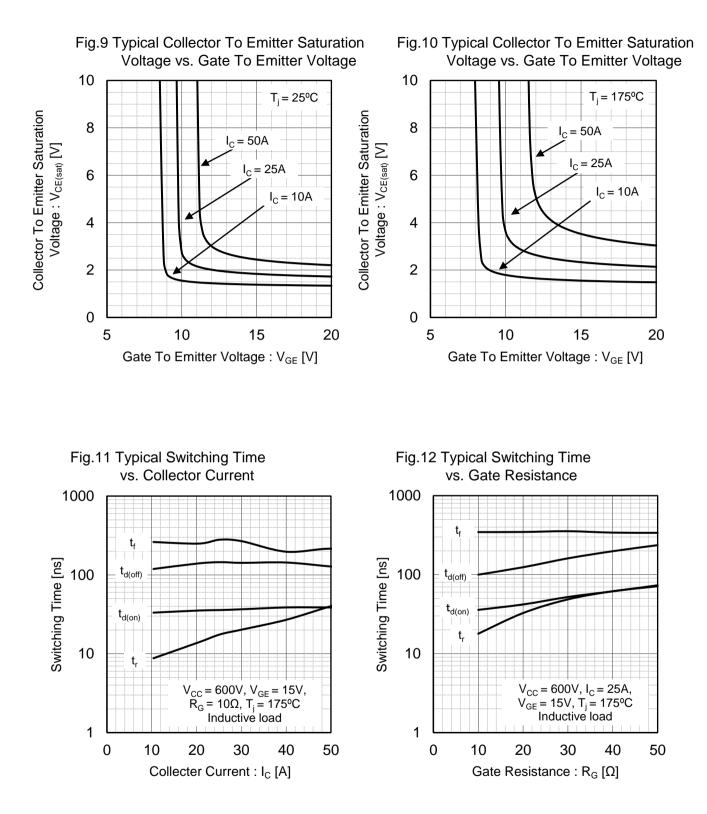
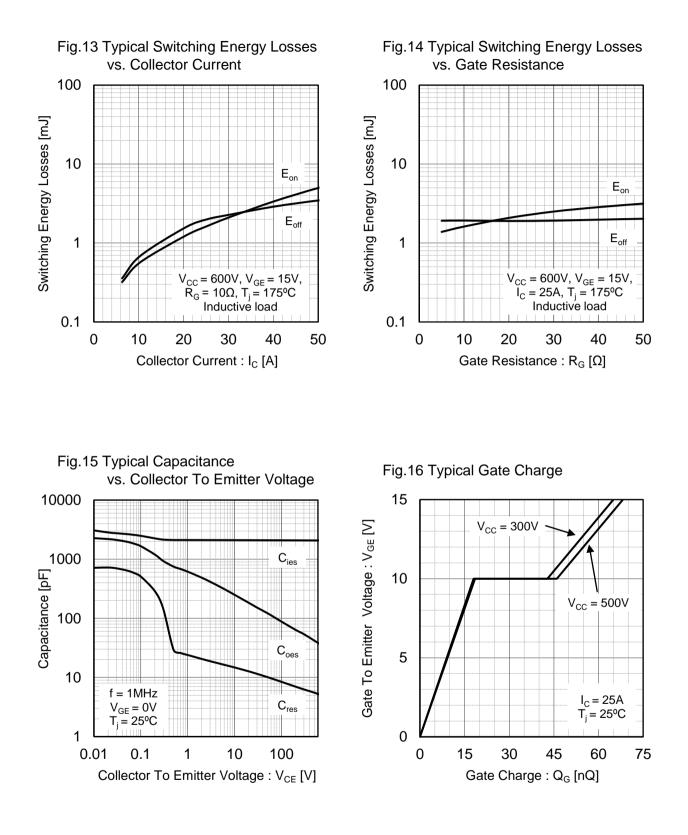
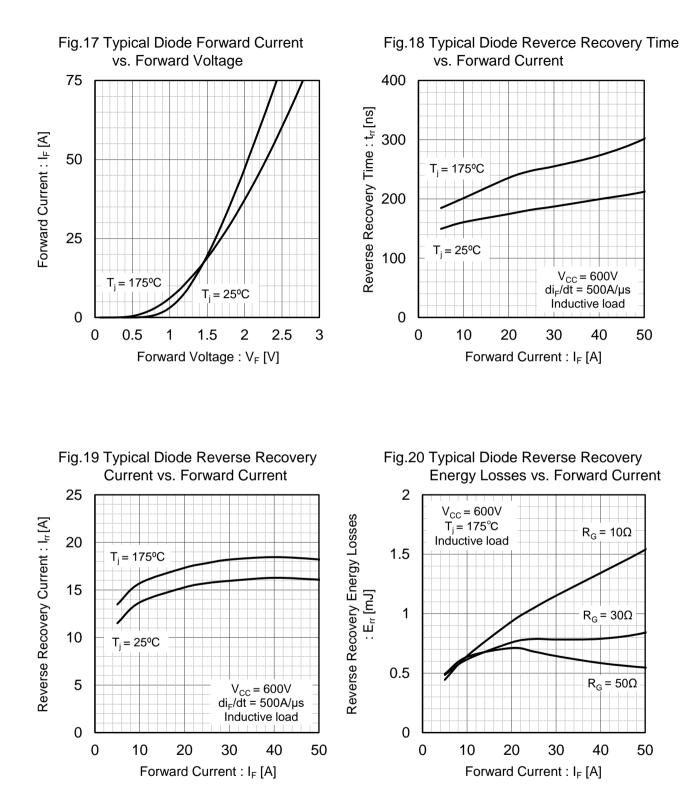


Fig.8 Typical Collector To Emitter Saturation Voltage vs. Junction Temperature









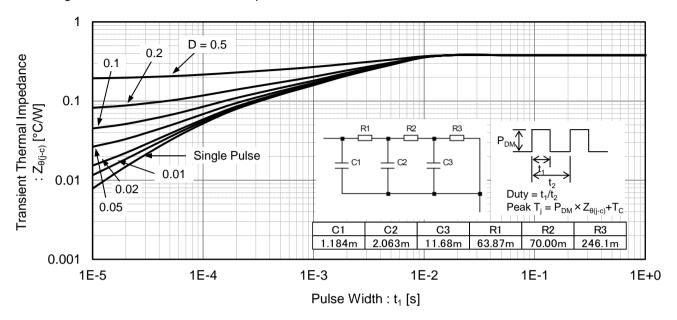
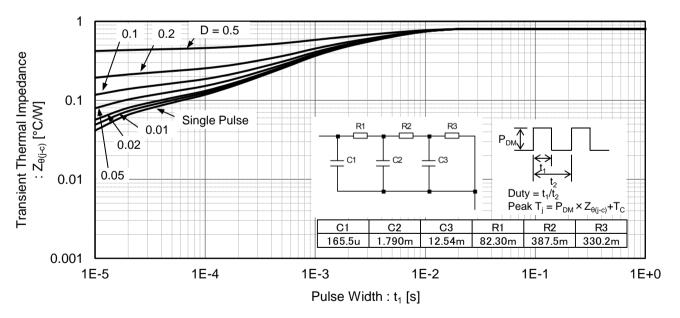


Fig.21 IGBT Transient Thermal Impedance

#### Fig.22 Diode Transient Thermal Impedance



#### Inductive Load Switching Circuit and Waveform

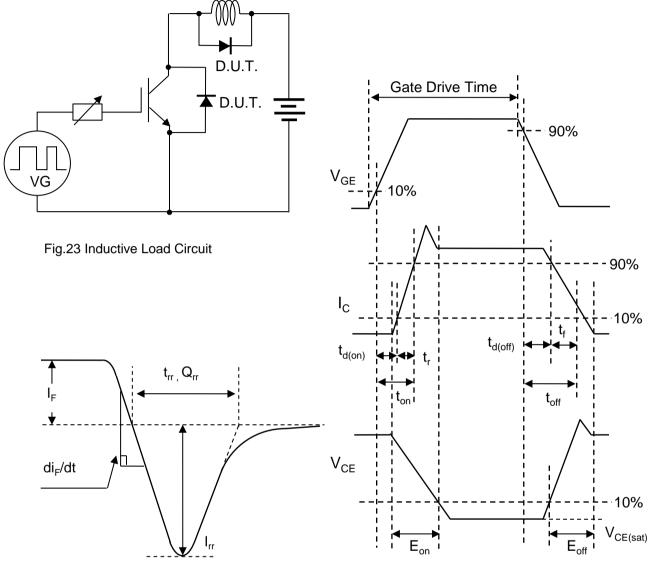


Fig.24 Diode Reverce Recovery Waveform

Fig.25 Inductive Load Waveform

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